



# P-Channel 40 V (D-S) MOSFET

| PRODUCT SUMMARY     |                                    |                                 |                       |  |  |  |
|---------------------|------------------------------------|---------------------------------|-----------------------|--|--|--|
| V <sub>DS</sub> (V) | $R_{DS(on)}$ ( $\Omega$ )          | I <sub>D</sub> (A) <sup>a</sup> | Q <sub>g</sub> (Typ.) |  |  |  |
| - 40                | 0.077 at V <sub>GS</sub> = - 10 V  | - 4.4                           | 7 nC                  |  |  |  |
|                     | 0.108 at V <sub>GS</sub> = - 4.5 V | - 3.7                           | 7 110                 |  |  |  |

#### **FEATURES**

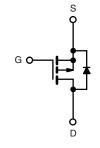
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- 100 % R<sub>g</sub> Tested
- Compliant to RoHS Directive 2002/95/EC



**FREE** 

## APPLICATIONS

- Load Switch
- DC/DC Converter



P-Channel MOSFET

|            | <b>TO-236</b> (SOT-23) |
|------------|------------------------|
| G 1<br>S 2 | 3 D                    |
|            | Top View               |
|            | Si2319CDS (P7)*        |
|            | * Marking Code         |

Ordering Information: Si2319CDS-T1-GE3 (Lead (Pb)-free and Halogen-free)

| Parameter  | Symbol                            | Limit              | Unit                  |    |
|--|-----------------------------------|--------------------|-----------------------|----|
| Drain-Source Voltage                               |                                   | V <sub>DS</sub>    | - 40                  | V  |
| Gate-Source Voltage                                |                                   | V <sub>GS</sub>    | ± 20                  | V  |
|  | T <sub>C</sub> = 25 °C            |                    | - 4.4                 |    |
| Continuous Drain Current /T 150 °C)                | T <sub>C</sub> = 70 °C            |                    | - 3.5                 |    |
| Continuous Drain Current (T <sub>J</sub> = 150 °C) | T <sub>A</sub> = 25 °C            | - I <sub>D</sub> - | - 3.1 <sup>b, c</sup> |    |
|  | T <sub>A</sub> = 70 °C            |                    | - 2.5 <sup>b, c</sup> | Α  |
| Pulsed Drain Current                               |                                   | I <sub>DM</sub>    | - 20                  |    |
| Continuo Course Drain Diade Current                | T <sub>C</sub> = 25 °C            |                    | - 2.1                 |    |
| Continous Source-Drain Diode Current               | T <sub>A</sub> = 25 °C            | l <sub>s</sub>     | - 1 <sup>b, c</sup>   |    |
|  | T <sub>C</sub> = 25 °C            |                    | 2.5                   |    |
| Maximum Dawar Dissipation                          | T <sub>C</sub> = 70 °C            |                    | 1.6                   | W  |
| Maximum Power Dissipation                          | T <sub>A</sub> = 25 °C            | P <sub>D</sub>     | 1.25 <sup>b, c</sup>  | VV |
|  | T <sub>A</sub> = 70 °C            | 1                  | 0.8 <sup>b, c</sup>   |    |
| Operating Junction and Storage Temperature         | T <sub>J</sub> , T <sub>stq</sub> | - 55 to 150        | °C                    |    |

| THERMAL RESISTANCE RATINGS                  |              |                   |         |         |        |  |  |
|---|--------------|-------------------|---------|---------|--------|--|--|
| Parameter                                   |              | Symbol            | Typical | Maximum | Unit   |  |  |
| Maximum Junction-to-Ambient <sup>b, d</sup> | t ≤ 5 s      | R <sub>thJA</sub> | 75      | 100     | °C/W   |  |  |
| Maximum Junction-to-Foot (Drain)            | Steady State | R <sub>thJF</sub> | 40      | 50      | - 'C/W |  |  |

#### Notes:

- a. Based on  $T_C = 25$  °C.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 5 s
- d. Maximum under steady state conditions is 166  $^{\circ}\text{C/W}.$

# **Si2319CDS**

# Vishay Siliconix



| <b>SPECIFICATIONS</b> $T_J = 25  ^{\circ}C$ , Parameter | Symbol                  | Test Conditions   | Min.    | Тур.  | Max.   | Unit  |  |
|---|-------------------------|---|---------|-------|--------|-------|--|
| Static  | Symbol                  | rest conditions   | IVIIII. | тур.  | IVIAA. | Oilit |  |
| Drain-Source Breakdown Voltage                          | V <sub>DS</sub>         | V <sub>GS</sub> = 0 V, I <sub>D</sub> = - 250 μA                          | - 40    |       |        | V     |  |
| V <sub>DS</sub> Temperature Coefficient                 | $\Delta V_{DS}/T_{J}$   |   |         | - 40  |        | mV/°C |  |
| V <sub>GS(th)</sub> Temperature Coefficient             | $\Delta V_{GS(th)}/T_J$ | - I <sub>D</sub> = - 250 μA   |         | 4.8   |        |       |  |
| Gate-Source Threshold Voltage                           | V <sub>GS(th)</sub>     | $V_{DS} = V_{GS}$ , $I_{D} = -250 \mu\text{A}$                            | - 1.2   |       | - 2.5  | V     |  |
| Gate-Source Leakage                                     | I <sub>GSS</sub>        | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$                         |         |       | ± 100  | nA    |  |
| ·   |                         | V <sub>DS</sub> = -40 V, V <sub>GS</sub> = 0 V                            |         |       | - 1    | μА    |  |
| Zero Gate Voltage Drain Current                         | I <sub>DSS</sub>        | V <sub>DS</sub> = - 40 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C   |         |       | - 5    |       |  |
| On-State Drain Current <sup>a</sup>                     | I <sub>D(on)</sub>      | $V_{DS} \le -5 \text{ V}, V_{GS} = -10 \text{ V}$                         | - 20    |       |        | Α     |  |
|   | . , ,                   | V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 3.1 A                        |         | 0.064 | 0.077  |       |  |
| Drain-Source On-State Resistance <sup>a</sup>           | R <sub>DS(on)</sub>     | V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 2.6 A                       |         | 0.090 | 0.108  | Ω     |  |
| Forward Transconductance <sup>a</sup>                   | 9 <sub>fs</sub>         | V <sub>DS</sub> = - 15 V, I <sub>D</sub> = - 3.1 A                        |         | 10    |        | S     |  |
| Dynamic <sup>b</sup>                                    |                         |   |         |       |        |       |  |
| Input Capacitance                                       | C <sub>iss</sub>        |   |         | 595   |        |       |  |
| Output Capacitance                                      | C <sub>oss</sub>        | V <sub>DS</sub> = - 20 V, V <sub>GS</sub> = 0 V, f = 1 MHz                |         | 76    |        | pF    |  |
| Reverse Transfer Capacitance                            | C <sub>rss</sub>        | 1   |         | 61    |        |       |  |
| Total Gate Charge                                       | $Q_g$                   | $V_{DS} = -20 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -3.1 \text{ A}$  |         | 13.6  | 21     | nC    |  |
|   |                         |   |         | 7     | 11     |       |  |
| Gate-Source Charge                                      | $Q_{gs}$                | $V_{DS} = -20 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -3.1 \text{ A}$ |         | 2.5   |        |       |  |
| Gate-Drain Charge                                       | $Q_{gd}$                |   |         | 3.2   |        |       |  |
| Gate Resistance   | $R_g$                   | f = 1 MHz   | 0.8     | 4.3   | 8.6    | Ω     |  |
| Turn-On Delay Time                                      | t <sub>d(on)</sub>      |   |         | 40    | 60     | ns    |  |
| Rise Time   | t <sub>r</sub>          | $V_{DD}$ = - 20 V, $R_L$ = 8 $\Omega$                                     |         | 27    | 41     |       |  |
| Turn-Off Delay Time                                     | t <sub>d(off)</sub>     | $I_D \cong -2.5 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$      |         | 18    | 27     |       |  |
| Fall Time   | t <sub>f</sub>          |   |         | 10    | 20     |       |  |
| Turn-On Delay Time                                      | t <sub>d(on)</sub>      |   |         | 8     | 16     |       |  |
| Rise Time   | t <sub>r</sub>          | $V_{DD}$ = - 20 V, $R_L$ = 8 $\Omega$                                     |         | 9     | 18     |       |  |
| Turn-Off Delay Time                                     | t <sub>d(off)</sub>     | $I_D \cong$ - 2.5 A, $V_{GEN}$ = - 10 V, $R_g$ = 1 $\Omega$               |         | 20    | 30     |       |  |
| Fall Time   | t <sub>f</sub>          |   |         | 8     | 16     |       |  |
| <b>Drain-Source Body Diode Characteristi</b>            | cs                      |   |         |       |        |       |  |
| Continuous Source-Drain Diode Current                   | I <sub>S</sub>          | T <sub>C</sub> = 25 °C  |         |       | - 2.1  | Α     |  |
| Pulse Diode Forward Current                             | I <sub>SM</sub>         |   |         |       | - 20   |       |  |
| Body Diode Voltage                                      | $V_{SD}$                | I <sub>S</sub> = - 2.5 A, V <sub>GS</sub> = 0 V                           |         | - 0.8 | - 1.2  | V     |  |
| Body Diode Reverse Recovery Time                        | t <sub>rr</sub>         |   |         | 17    | 26     | ns    |  |
| Body Diode Reverse Recovery Charge                      | Q <sub>rr</sub>         | I <sub>F</sub> = - 2.5 A, dl/dt = 100 A/μs, T <sub>J</sub> = 25 °C        |         | 9     | 18     | nC    |  |
| Reverse Recovery Fall Time                              | t <sub>a</sub>          | 1 i <sub>F</sub> = -2.5 A, αί/αι = 100 A/μs, 1j = 25 °C                   |         | 10    |        |       |  |
| Reverse Recovery Rise Time t <sub>b</sub>               |                         | ]   |         | 7     |        | ns    |  |

#### Notes:

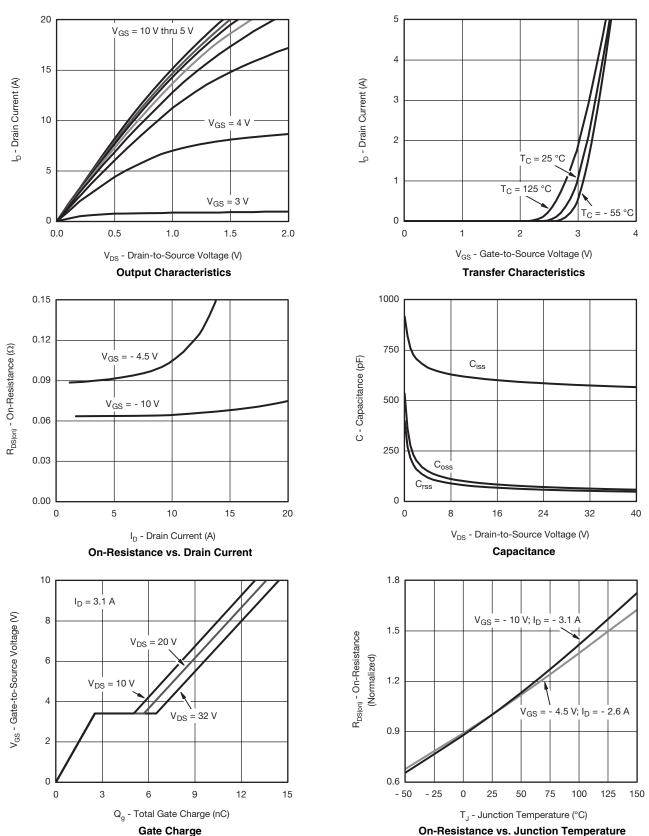
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

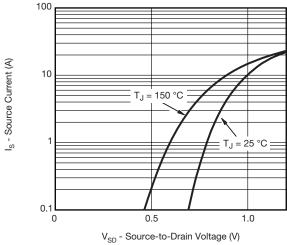


#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

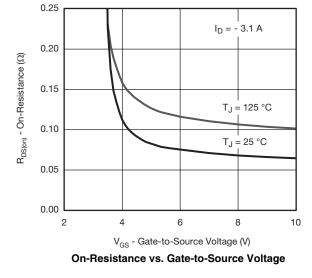


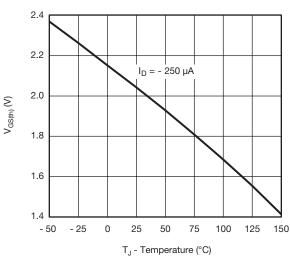
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## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

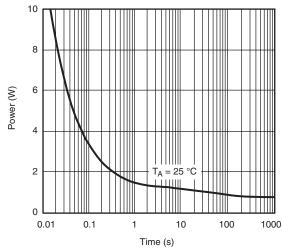


Source-Drain Diode Forward Voltage

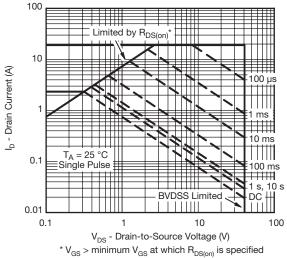




**Threshold Voltage** 



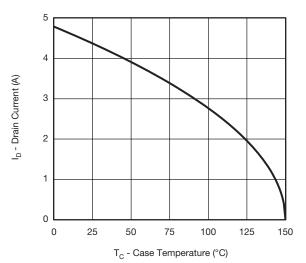
Single Pulse Power (Junction-to-Ambient)



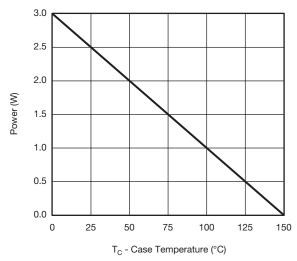
Safe Operating Area, Junction-to-Ambient

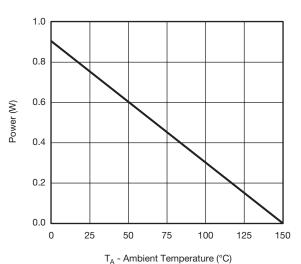


#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



#### **Current Derating\***





Power, Junction-to-Ambient

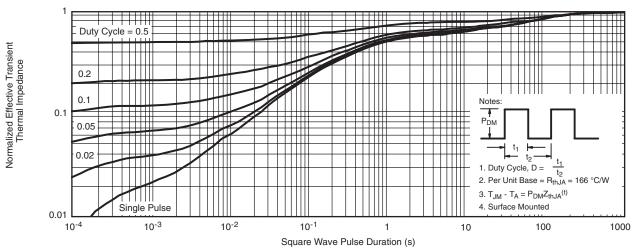
Power, Junction-to-Foot

 $<sup>^{\</sup>star}$  The power dissipation P<sub>D</sub> is based on T<sub>J(max)</sub> = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

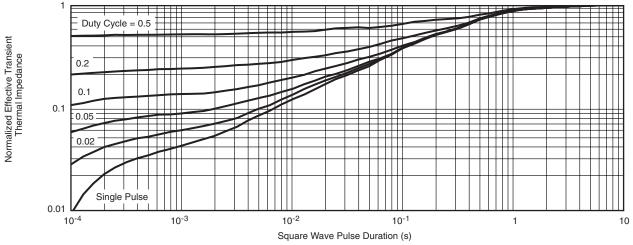
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## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient

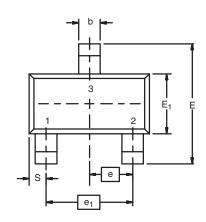


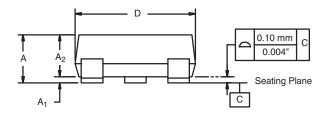
Normalized Thermal Transient Impedance, Junction-to-Foot

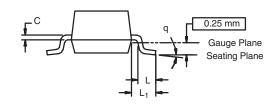
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## SOT-23 (TO-236): 3-LEAD







| Dim                    | MILLI    | METERS | INCHES     |       |  |
|------------------------|----------|--------|------------|-------|--|
|                        | Min      | Max    | Min        | Max   |  |
| Α                      | 0.89     | 1.12   | 0.035      | 0.044 |  |
| A <sub>1</sub>         | 0.01     | 0.10   | 0.0004     | 0.004 |  |
| A <sub>2</sub>         | 0.88     | 1.02   | 0.0346     | 0.040 |  |
| b                      | 0.35     | 0.50   | 0.014      | 0.020 |  |
| С                      | 0.085    | 0.18   | 0.003      | 0.007 |  |
| D                      | 2.80     | 3.04   | 0.110      | 0.120 |  |
| Е                      | 2.10     | 2.64   | 0.083      | 0.104 |  |
| E <sub>1</sub>         | 1.20     | 1.40   | 0.047      | 0.055 |  |
| е                      | 0.95 BSC |        | 0.0374 Ref |       |  |
| e <sub>1</sub>         | 1.90 BSC |        | 0.0748 Ref |       |  |
| L                      | 0.40     | 0.60   | 0.016      | 0.024 |  |
| L <sub>1</sub>         | 0.64 Ref |        | 0.025 Ref  |       |  |
| S                      | 0.50 Ref |        | 0.020 Ref  |       |  |
| q                      | 3°       | 8°     | 3°         | 8°    |  |
| FCN: S-03946-Rev K 09- | lul-01   |        |            |       |  |

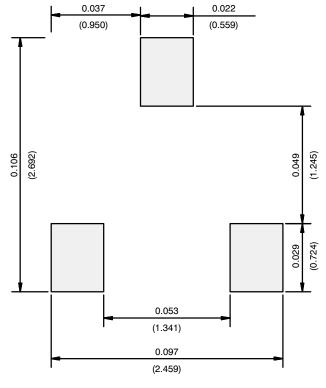
ECN: S-03946-Rev. K, 09-Jul-01

DWG: 5479

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#### **RECOMMENDED MINIMUM PADS FOR SOT-23**



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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